

Product Summary

Part Number	R1 (NOM)	R2 (NOM)	Marking
DDTA144ELP	47kΩ	47kΩ	P2

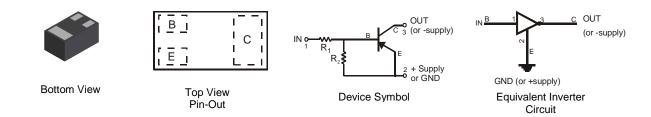
Features

- Epitaxial Planar Die Construction
- Ultra-Small Leadless Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- Totally Lead Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

X1-DFN1006-3



- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.0009 grams (Approximate)



Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DDTA144ELP-7	P2	7	8	3,000
DDTA144ELP-7B	P2	7	8	10,000

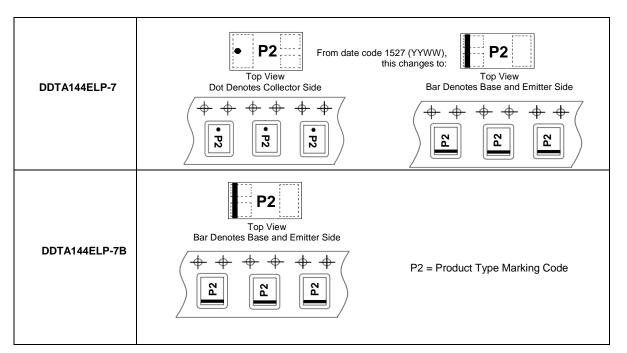
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	V _{CC}	-50	V
Input Voltage	V _{IN}	+10 to -40	V
Output Current (I _o)	I _{C(MAX)}	-200	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	250	mW
Power Deration above +25°C	P _{der}	2	mW/°C
Thermal Resistance, Junction to Ambient Air (Note 5) (Equivalent to one heated junction of PNP)	R _θ JA	500	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Off Characteristics (Notes 6 & 7)			71			
Collector-Base Breakdown Voltage	BV _{CBO}	-50			V	$I_{\rm C} = -10\mu A, I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	BV _{CEO}	-50			V	$I_{\rm C} = -1 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-4.5			V	$I_{\rm E} = -100 \mu A, I_{\rm C} = 0$
Collector Cutoff Current	ICEX			-100	nA	$V_{CE} = -50V, V_{EB(OFF)} = 3V$
Base Cutoff Current (I _{BEX})	I _{BL}			-60	μA	$V_{CE} = -50V, V_{EB(OFF)} = 3V$
Collector-Base Cut Off Current	Ісво			-100	nA	$V_{CB} = -50V, I_E = 0$
Collector-Emitter Cut Off Current, IO(off)	I _{CES}			-100	nA	$V_{CE} = -50V, I_{B} = 0$
Emitter-Base Cut Off Current	I _{EBO}	_	_	-100	μA	$V_{EB} = -4V, I_{C} = 0$
Input Off Voltage	V _{I(off)}	-300			mV	V _{CC} = -5V, I _O = -100uA
On Characteristics (Notes 6 & 7)	• • •					·
Input-On Voltage	V _{I(on)}	_	—	-3	V	$V_0 = -0.3V, I_0 = -5mA$
Input Current	h		_	-180	μA	$V_{I} = -5V$
		90	_	_	—	$V_{CE} = -5V, I_{C} = -2.5mA$
	hfe	120	_	_	_	$V_{CE} = -5V, I_{C} = -5mA$
DC Current Gain		150			_	V _{CE} = -5V, I _C = -10mA
DC Current Gain		100	_	_	_	V _{CE} = -5V, I _C = -100mA
		180	_	_	_	V _{CE} = -5V, I _C = -200mA
		250	_	_	_	V _{CE} = -5V, I _C = -300mA
Output On Voltage				-150	mV	I _I = -1mA, I _O = -10mA
(Collector-Emitter Saturation Voltage)	V _{O(on)}			-800	mV	I _I = -1mA, I _O = -40mA
Input Resistance	R1	33	47	61	kΩ	
Resistance Ratio	(R2/R1)	0.8	1	1.2		—
Small Signal Characteristics						
Current Gain-Bandwidth Product	f⊤		250		MHz	V _{CE} = -10V, I _E = -5mA, f = 100 MHz

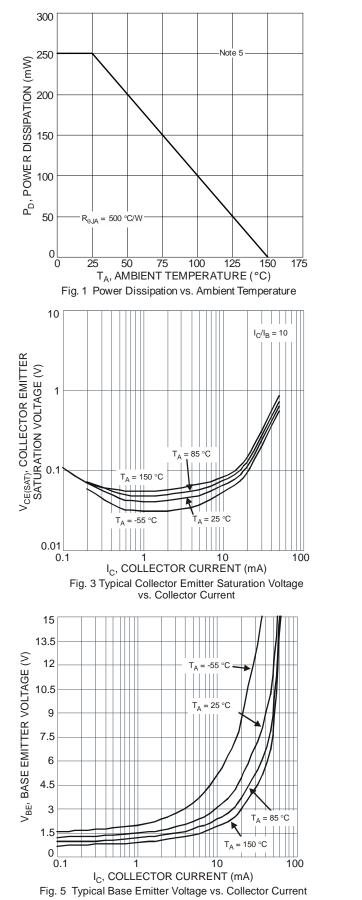
Notes: 5. For the device mounted on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady state condition. The entire exposed collector pad is attached to the heatsink.

6. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

7. Guaranteed by design.



DDTA144ELP



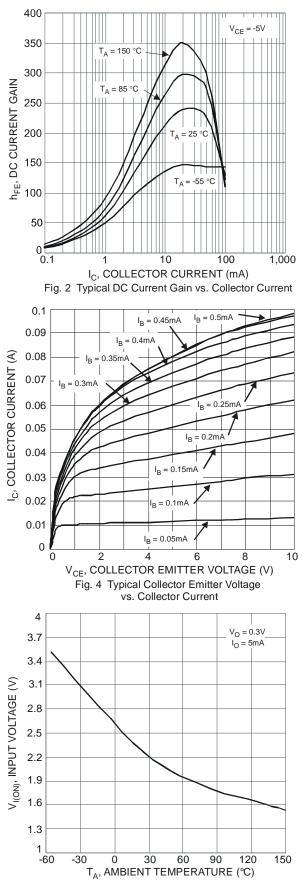
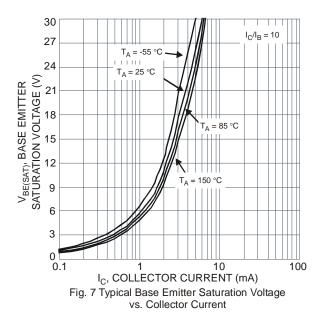


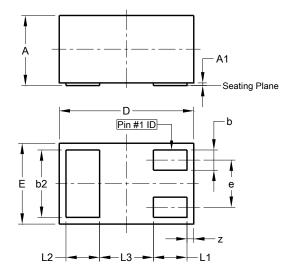
Fig. 6 Typical Input Voltage vs. Ambient Temperature





Package Outline Dimensions

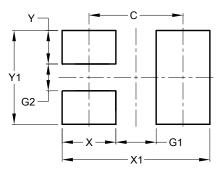
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN1006-3				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0.00	0.05	0.03	
b	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
D	0.95	1.075	1.00	
ш	0.55	0.675	0.60	
e	1	-	0.35	
L1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3	-	-	0.40	
Z	0.02	0.08	0.05	
All Dimensions in mm			n mm	

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Y	0.25
Y1	0.70



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